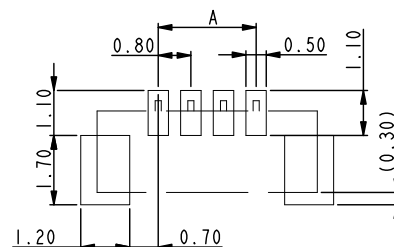
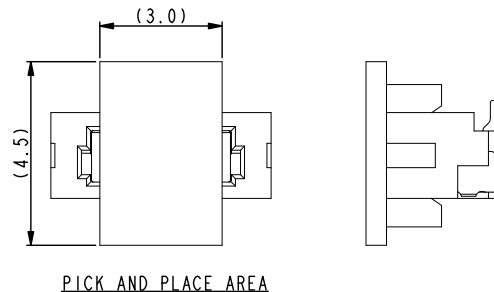
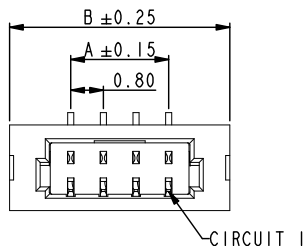
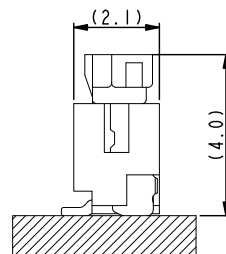
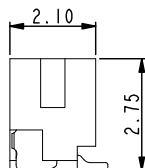
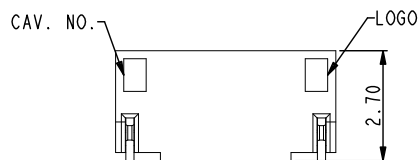


REV.	DESCRIPTION	DATE
A	New Drawing	2017/09/13

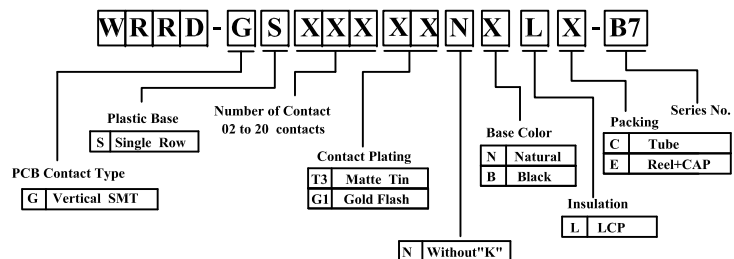


TOLERANCE: ± 0.05
RECOMMENDED P.C.B. Layout
TOP VIEW



Mating Condition (REF.)

PIN	A	B	PIN	A	B
02	0.80	3.80	12	8.80	11.80
03	1.60	4.60	13	9.60	12.60
04	2.40	5.40	14	10.40	13.40
05	3.20	6.20	15	11.20	14.20
06	4.00	7.00	16	12.00	15.00
07	4.80	7.80	17	12.80	15.80
08	5.60	8.60	18	13.60	16.60
09	6.40	9.40	19	14.40	17.40
10	7.20	10.20	20	15.20	18.20
11	8.00	11.00			



RoHS compliant

1	CONTACT	COPPER ALLOY, $\pm 0.15\text{mm}$	(VOID): MATTE TIN PLATED OVER NICKEL GO: GOLD FLASH PLATED ON CONTACT AREA, OVER NICKEL G*: *u* GOLD PLATED ON CONTACT AREA, OVER NICKEL
2	INSULATION	THERMOPLASTIC HIGH TEMP., UL94V-0 (HALOGEN FREE)COLOR: CREAM	
3	SOLDER TAB	COPPER ALLOY, $\pm 0.20\text{mm}$	MATTE TIN PLATED OVER NICKEL
INDEX	PART NAME	MATERIAL	FINISH

General Tolerance		TITLE	0.8mm Wafer	
X. ± 0.5		DRAWN	DATE	NO.
.X ± 0.3		Andy	09-13-17'	T057
.XX ± 0.2		CHECK	DATE	PART NO.
.XXX ± 0.1		APPROVED	DATE	WRRD-CSXXXXXXNXLX-B7
角度	$\pm 5^\circ$			CUSTOMER NO.

竣豪電子股份有限公司 Superior Tech Co., Ltd.			
REV. A	UNIT mm	SCALE 1:1	